# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

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### **RFBPF Series – 2012(0805)- RoHS Compliance**

### MULTILAYER CERAMIC BAND PASS FILTER

### **Halogens Free Product**

### 2.4 GHz ISM Band Working Frequency

## **P/N: RFBPF2012080AFT**

\*Contents in this sheet are subject to change without prior notice.

#### **Approval sheet**



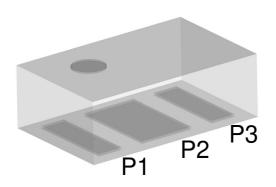
#### FEATURES

- 1. Miniature footprint: 2.0 X 1.2 X 0.8 mm<sup>3</sup>
- 2. Low Insertion Loss
- 3. High Rejection on GSM Bands
- 4. High attenuation on 2170 MHz & 2<sup>nd</sup> harmonic suppressed
- 5. LTCC process

#### APPLICATIONS

- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g/n, HomeRF

#### CONSTRUCTION



PIN	Connection	
1	Input port	
2	GND	
3	Output port	

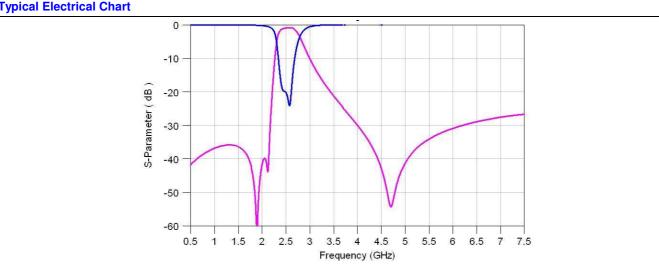
#### DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	2.00 ± 0.15
	W	1.25 ± 0.10
F	Т	0.80 ± 0.10
W A	A	0.95 ± 0.10
V ·	В	0.275 ± 0.10
τŢ	С	0.25 ± 0.10
' <u>*</u>	D	0.60 ± 0.10
	E	0.175 ± 0.10
	F	0.15 ± 0.10

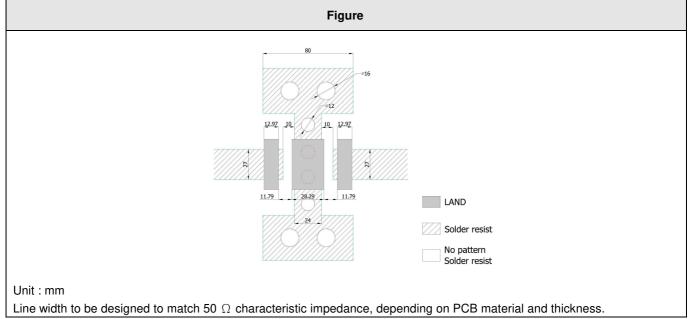
#### **Approval sheet**

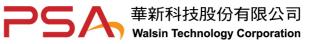
#### ELECTRICAL CHARACTERISTICS

RFBPF2012080AFT	Specification
Frequency range	2450± 50 MHz
Insertion Loss	1.8 dB at 25°C
	2.0 dB at -40°C ~ +85°C
VSWR	2.0 max
Impedance	<b>50</b> Ω
	30@ 824~ 915MHz
	30@ 1545~ 1605MHz
	35@ 1710~ 1990MHz
Attenuation (min.)	30@ 2170MHz
	30@ 4800~ 4967MHz
	25@ 5150 ~ 6000MHz
	20@ 7200~ 7450.5MHz
Operation Temperature Range	-40°C ~ +85°C
Typical Electrical Chart	



#### SOLDER LAND PATTERN





#### Approval sheet

#### **RELIABILITY TEST**

Test item	Test condition / Test method	Specification	
Solderability JIS C 0050-4.6	*Solder bath temperature : $235 \pm 5^{\circ}C$	At least 95% of a surface of each terminal	
JESD22-B102D	*Immersion time : $2 \pm 0.5$ sec	electrode must be covered by fresh solder.	
	Solder : Sn3Ag0.5Cu for lead-free		
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : 260 ± 5°C *Leaching immersion time : 30 ± 0.5 sec	Loss of metallization on the edges of each electrode shall not exceed 25%.	
120 00000-2-38	Solder : SN63A		
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature ÷ 120~150℃, 1 minute.	No mechanical damage. Samples shall satisfy electrical specification	
	*Solder temperature : 270±5°C	after test.	
	*Immersion time : 10±1 sec	Loss of metallization on the edges of each	
	Solder : Sn3Ag0.5Cu for lead-free	electrode shall not exceed 25%.	
	Measurement to be made after keeping at room temperature for 24±2 hrs		
Drop Test JIS C 0044 Customer's specification.	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel.	No mechanical damage. Samples shall satisfy electrical specification after test.	
	*Times : 6 surfaces for each units ; 2 times for each side.		
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N(≦0603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination.	
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and	No mechanical damage. Samples shall satisfy electrical specification after test.	
	then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours		

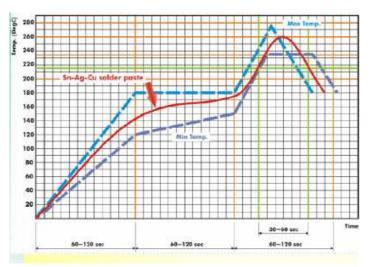
### **PSA** 華新科技股份有限公司 Walsin Technology Corporation

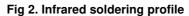
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Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.	
JIS C 0025	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical	
	3. 30±3 minutes at +85°C±3°C,	specification after test.	
	4. 10~15 minutes at room temperature,		
	Total 100 continuous cycles		
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		
Vibration	*Frequency : 10Hz~55Hz~10Hz(1min)	No mechanical damage.	
JIS C 0040	*Total amplitude : 1.5mm	Samples shall satisfy electrical specification	
	*Test times : 6hrs.(Two hrs each in three	after test.	
	mutually perpendicular directions)		
High temperature	*Temperature: 85°C±2°C	No mechanical damage.	
JIS C 0021	*Test duration : 1000+24/-0 hours	Samples shall satisfy electrical specification	
	Measurement to be made after keeping at	after test.	
	room temperature for 24±2 hrs		
Humidity	*Humidity : 90% to 95% R.H.	No mechanical damage.	
(steady conditions)	*Temperature : 40±2°C	Samples shall satisfy electrical specification	
JIS C 0022	*Time : 1000+24/-0 hrs.	after test.	
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		
	% 500hrs measuring the first data then		
	1000hrs data		
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.	
JIS C 0020	*Test duration : 1000+24/-0 hours	Samples shall satisfy electrical specification	
	Measurement to be made after keeping at	after test.	
	room temperature for 24±2 hrs		
		1	

#### SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,



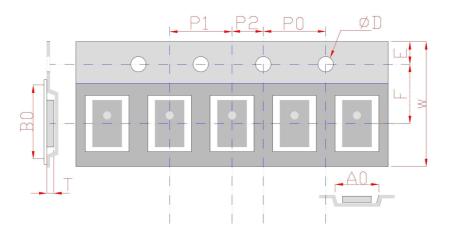


#### **ORDERING CODE**

RF	BPF	201208	0	Α	F	Т
Walsin	Product Code	Dimension code	Unit of	Application	Specification	Packing
RF	BPF :	Per 2 digits of	dimension	A : 2.4GHZ ISM	Design code	T : Reeled
device	Band Pass Filter	Length, Width,	0 :0.1 mm	Band		
		Thickness :	1 :1.0 mm			
		e.g. :				
		201208 =				
		Length 20,				
		Width 12,				
		Thickness 08				

Minimum Ordering Quantity: 2000 pcs per reel.

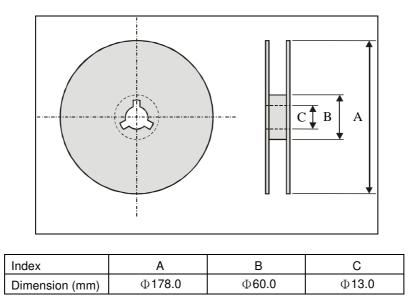
#### PACKAGING



#### Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	$1.45\pm0.10$	$\textbf{2.25}\pm\textbf{0.10}$	1.55 + 0.10	$1.10\pm0.10$	$8.0\pm0.10$
Index	E	F	Po	P1	P2
Dimension (mm)	$1.75\pm0.10$	$3.50\pm0.05$	$4.00\pm0.10$	$4.00\pm0.10$	$2.00\pm0.10$

#### **Reel dimensions**



Taping Quantity: 2000 pieces per 7" reel

#### CAUTION OF HANDLING

#### Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

#### Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.
  - Temperature : -10 to +40°C
  - Humidity : 30 to 70% relative humidity
  - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
  - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
  - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
  - Products should be storage under the airtight packaged condition.